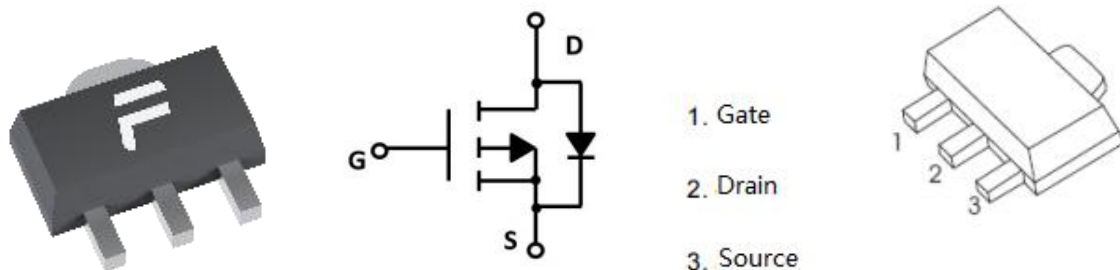


**SOT-89-3L -15V P Channel Enhancement 沟道增强型
MOS Field Effect Transistor 场效应管**



■ **Absolute Maximum Ratings 最大额定值**

Characteristic 特性参数	Symbol 符号	Rat 额定值	Unit 单位
Drain-Source Voltage 漏极-源极电压	BV_{DSS}	-15	V
Gate- Source Voltage 栅极-源极电压	V_{GS}	± 12	V
Drain Current (continuous)漏极电流-连续	I_D (at $T_A = 25^\circ\text{C}$)	-15	A
Drain Current (pulsed)漏极电流-脉冲	I_{DM}	-60	A
Total Device Dissipation 总耗散功率	P_D (at $T_A = 25^\circ\text{C}$)	3000	mW
Thermal Resistance Junction-Ambient 热阻	$R_{\theta JA}$	42	$^\circ\text{C}/\text{W}$
Junction/Storage Temperature 结温/储存温度	T_J, T_{stg}	-55~150	$^\circ\text{C}$

■ **Device Marking 产品字标**

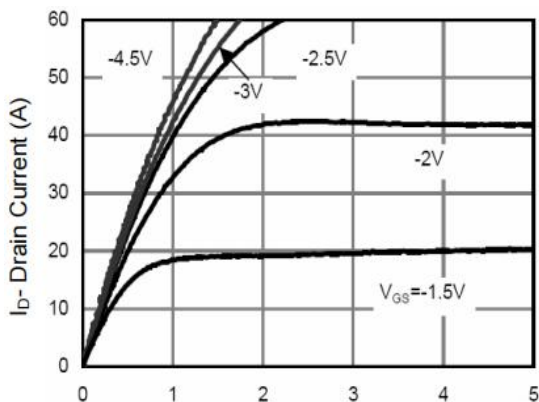
FS15P02F=15P02

■ Electrical Characteristics 电特性

 (T_A=25℃ unless otherwise noted 如无特殊说明, 温度为 25℃)

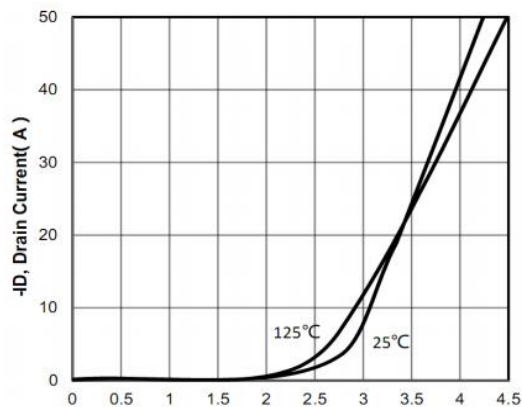
Characteristic 特性参数	Symbol 符号	Min 最小值	Typ 典型值	Max 最大值	Unit 单位
Drain-Source Breakdown Voltage 漏极-源极击穿电压(I _D = -250uA, V _{GS} =0V)	BV _{DSS}	-15	-18	—	V
Gate Threshold Voltage 栅极开启电压(I _D = -250uA, V _{GS} = V _{DS})	V _{GS(th)}	-0.4	-0.65	-0.95	V
Zero Gate Voltage Drain Current 零栅压漏极电流(V _{GS} =0V, V _{DS} = -12V)	I _{DSS}	—	—	-1	uA
Gate Body Leakage 栅极漏电流(V _{GS} =±12V, V _{DS} =0V)	I _{GSS}	—	—	±100	nA
Static Drain-Source On-State Resistance 静态漏源导通电阻(I _D = -7A, V _{GS} = -4.5V) (I _D = -5A, V _{GS} = -2.5V)	R _{DS(ON)}	—	12.5 17	18 23	mΩ
Diode Forward Voltage Drop 内附二极管正向压降(I _{SD} = -5A, V _{GS} =0V)	V _{SD}	—	—	-1.2	V
Input Capacitance 输入电容 (V _{GS} =0V, V _{DS} = -10V, f=1MHz)	C _{ISS}	—	2700	—	pF
Common Source Output Capacitance 共源输出电容(V _{GS} =0V, V _{DS} = -10V, f=1MHz)	C _{OSS}	—	680	—	pF
Reverse Transfer Capacitance 反馈电容 (V _{GS} =0V, V _{DS} = -10V, f=1MHz)	C _{RSS}	—	590	—	pF
Total Gate Charge 栅极电荷密度 (V _{DS} = -6V, I _D = -9A, V _{GS} = -4.5V)	Q _g	—	35	—	nC
Gate Source Charge 栅源电荷密度 (V _{DS} = -6V, I _D = -9A, V _{GS} = -4.5V)	Q _{gs}	—	5	—	nC
Gate Drain Charge 栅漏电荷密度 (V _{DS} = -6V, I _D = -9A, V _{GS} = -4.5V)	Q _{gd}	—	10	—	nC
Turn-ON Delay Time 开启延迟时间 (V _{DS} = -10V I _D = -1A, R _{GEN} =10Ω, V _{GS} = -4.5V)	t _{d(on)}	—	11	—	ns
Turn-ON Rise Time 开启上升时间 (V _{DS} = -10V I _D = -1A, R _{GEN} =10Ω, V _{GS} = -4.5V)	t _r	—	35	—	ns
Turn-OFF Delay Time 关断延迟时间 (V _{DS} = -10V I _D = -1A, R _{GEN} =10Ω, V _{GS} = -4.5V)	t _{d(off)}	—	30	—	ns
Turn-OFF Fall Time 关断下降时间 (V _{DS} = -10V I _D = -1A, R _{GEN} =10Ω, V _{GS} = -4.5V)	t _f	—	10	—	ns

■ Typical Characteristic Curve 典型特性曲线



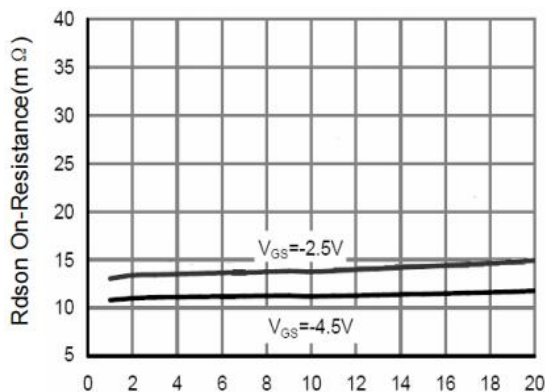
-V_{DS} Drain-Source Voltage (V)

Figure 1: Output Characteristics



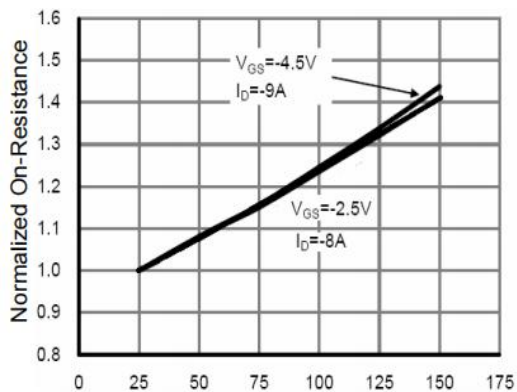
-V_{GS} Gate-Source Voltage (V)

Figure 2: Transfer Characteristics



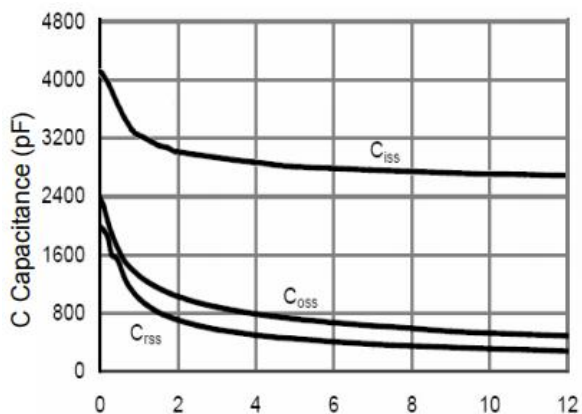
-I_D Drain Current (A)

Figure 3: On-Resistance vs. Drain Current



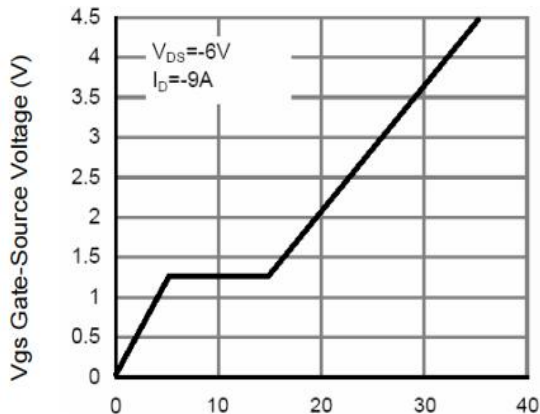
T_J Junction Temperature (°C)

Figure 4: On-Resistance vs. Temperature



-V_{DS} Drain-Source Voltage (V)

Figure 5: Capacitance Characteristics



Qg Gate Charge(nc)

Figure 6: Gate-Charge Characteristics

■ Typical Characteristic Curve 典型特性曲线

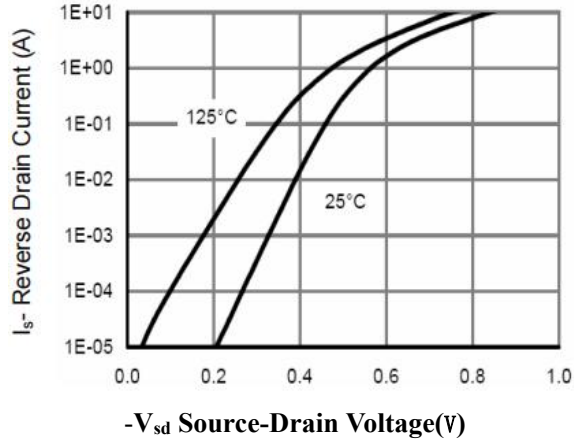


Figure 7: Body Diode Characteristics

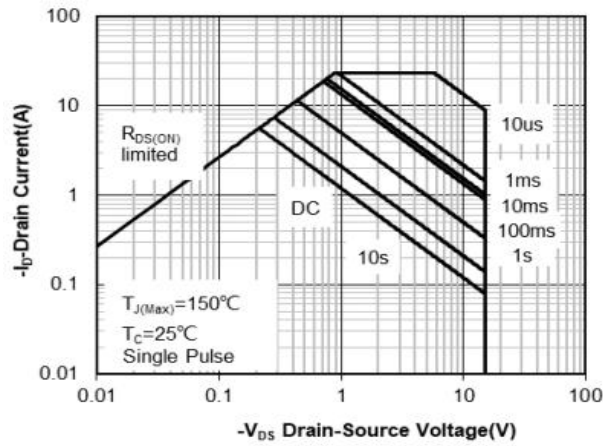


Figure8: Safe Operating Area

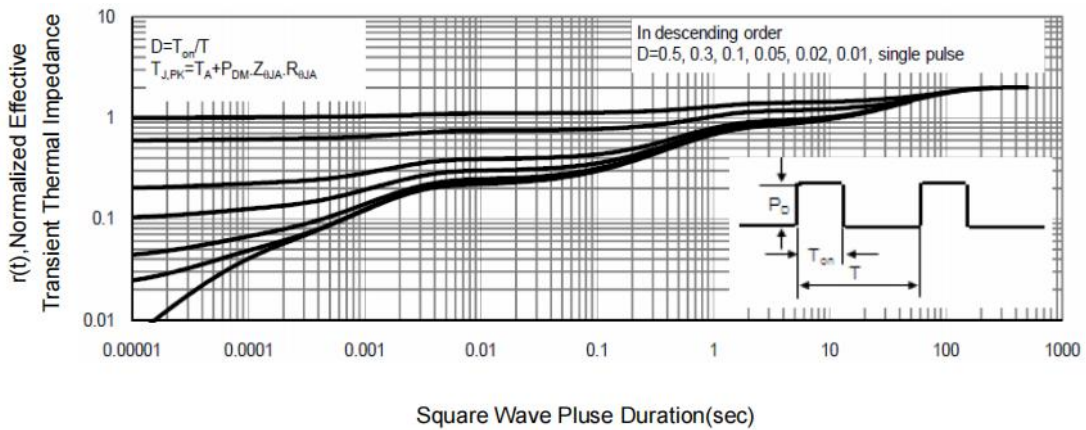
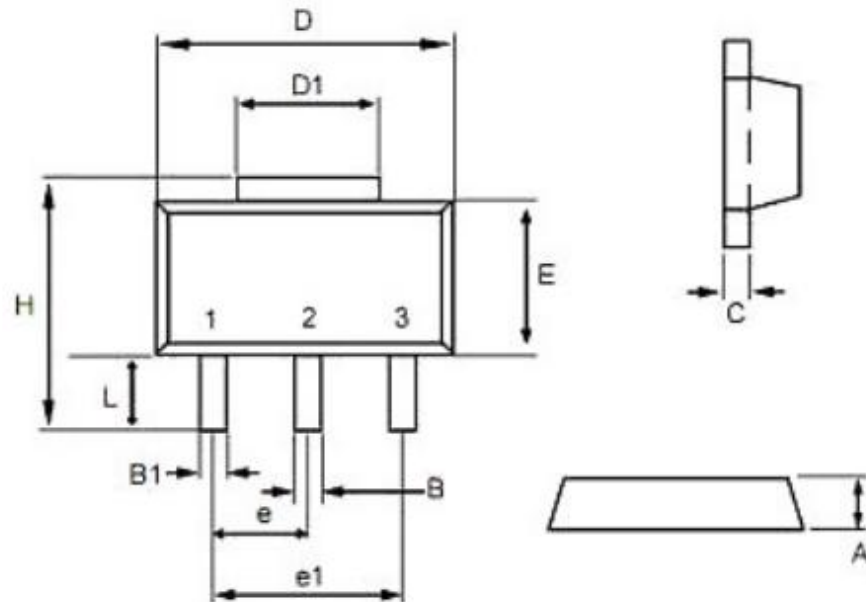


Figure 9: Transient Thermal Response Curve

■ Dimension 外形封装尺寸



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.40	1.60	0.055	0.063
B	0.40	0.56	0.016	0.022
B1	0.35	0.48	0.014	0.019
C	0.35	0.44	0.014	0.017
D	4.40	4.60	0.173	0.181
D1	1.35	1.83	0.053	0.072
e	1.45	1.55	0.057	0.061
e1	2.95	3.05	0.116	0.120
E	2.29	2.60	0.090	0.102
H	3.75	4.25	0.148	0.167
L	0.80	1.20	0.031	0.047